



SDI FINAL EVALUATION FORM 1.1

PART 1:

Journal Name:	Physical Science International Journal
Manuscript Number:	2014_PSIJ_13963
Title of the Manuscript:	THERMOELECTRIC PROPERTIES OF LEAD TELLURIDE FILLED IN SILICONE

PART 2:

FINAL EVALUATOR'S comments on revised paper (if any)	Authors' response to final evaluator's comments
Accept	

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